

## Features

- N-Channel  
30V/7A,  
 $R_{DS\ (ON)} = 19m\Omega$  (Typ.) @  $V_{GS}=10V$   
 $R_{DS\ (ON)} = 27m\Omega$  (Typ.) @  $V_{GS}=4.5V$
- P-Channel  
-30V/-5A,  
 $R_{DS\ (ON)} = 38m\Omega$  (Typ.) @  $V_{GS}=-10V$   
 $R_{DS\ (ON)} = 53m\Omega$  (Typ.) @  $V_{GS}=-4.5V$
- Optimized Gate Charge to Minimize Switching Losses
- Low Capacitance to Minimize Driver Losses

## Applications

- Load Switch

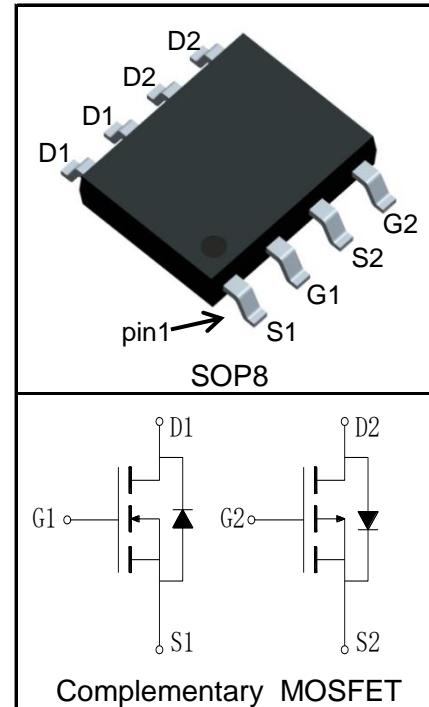


Halogen-Free

## Absolute Maximum Ratings

Symbol	Parameter	N-Channel	P-Channel	Unit
<b>Common Ratings</b> ( $T_A=25^\circ C$ Unless Otherwise Noted)				
$V_{DSS}$	Drain-Source Voltage	30	-30	V
$V_{GSS}$	Gate-Source Voltage	$\pm 20$	$\pm 20$	
$T_J$	Maximum Junction Temperature	150	150	$^\circ C$
$T_{STG}$	Storage Temperature Range	-55 to 150	-55 to 150	$^\circ C$
$I_S$	Diode Continuous Forward Current	$T_A=25^\circ C$	1.6	-1.6
<b>Mounted on Large Heat Sink</b>				
$I_{DP}^{(1)}$	300 $\mu s$ Pulse Drain Current Tested	$T_A=25^\circ C$	28	-20
$I_D^{(2)}$	Continuous Drain Current( $V_{GS}=\pm 10V$ )	$T_A=25^\circ C$	7	-5
		$T_A=70^\circ C$	5.6	-4
$P_D$	Maximum Power Dissipation	$T_A=25^\circ C$	2	2
		$T_A=70^\circ C$	1.3	1.3
$R_{\theta JL}$	Thermal Resistance-Junction to Lead	40	40	$^\circ C/W$
$R_{\theta JA}^{(3)}$	Thermal Resistance-Junction to Ambient	62.5	62.5	$^\circ C/W$
<b>Drain-Source Avalanche Ratings</b>				
$E_{AS}^{(4)}$	Avalanche Energy, Single Pulsed	9	6	mJ

## Pin Description



**Electrical Characteristics** ( $T_A=25^\circ\text{C}$  Unless Otherwise Noted)

Symbol	Parameter	Test Condition	KS3644HA			Unit	
			Min.	Typ.	Max.		
<b>Static Characteristics</b>							
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{DS}}=250\mu\text{A}$	N	30		V	
		$V_{\text{GS}}=0\text{V}, I_{\text{DS}}=-250\mu\text{A}$	P	-30			
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{\text{DS}}=30\text{V}, V_{\text{GS}}=0\text{V}$	N		1	$\mu\text{A}$	
		$T_J=125^\circ\text{C}$			30		
		$V_{\text{DS}}=-30\text{V}, V_{\text{GS}}=0\text{V}$	P		-1		
		$T_J=125^\circ\text{C}$			-30		
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{DS}}=250\mu\text{A}$	N	1.1	1.5	V	
		$V_{\text{DS}}=V_{\text{GS}}, I_{\text{DS}}=-250\mu\text{A}$	P	-1.1	-1.5		
$I_{\text{GSS}}$	Gate Leakage Current	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$	N		$\pm 100$	nA	
		$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$	P		$\pm 100$		
$R_{\text{DS}(\text{ON})}^{(5)}$	Drain-Source On-state Resistance	$V_{\text{GS}}=10\text{V}, I_{\text{DS}}=7\text{A}$	N		19	$\text{m}\Omega$	
		$V_{\text{GS}}=-10\text{V}, I_{\text{DS}}=-7\text{A}$	P		38		
		$V_{\text{GS}}=4.5\text{V}, I_{\text{DS}}=5\text{A}$	N		27		
		$V_{\text{GS}}=-4.5\text{V}, I_{\text{DS}}=-5\text{A}$	P		53		
<b>Diode Characteristics</b>							
$V_{\text{SD}}^{(5)}$	Diode Forward Voltage	$I_{\text{SD}}=7\text{A}, V_{\text{GS}}=0\text{V}$	N		0.87	V	
		$I_{\text{SD}}=-7\text{A}, V_{\text{GS}}=0\text{V}$	P		-0.94		
$t_{\text{rr}}$	Reverse Recovery Time	N-Channel $I_{\text{SD}}=7\text{A}, dI_{\text{SD}}/dt=100\text{A}/\mu\text{s}$	N		9	ns	
			P		13		
$Q_{\text{rr}}$	Reverse Recovery Charge		N		5	nC	
			P		8		
<b>Dynamic Characteristics</b> <sup>(6)</sup>							
$R_{\text{G}}$	Gate Resistance	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=0\text{V}, F=1\text{MHz}$	N		1.6	$\Omega$	
			P		5.9		
$C_{\text{iss}}$	Input Capacitance	N-Channel $V_{\text{GS}}=0\text{V}, V_{\text{DS}}=15\text{V}$ , Frequency=1.0MHz	N		395	$\text{pF}$	
			P		680		
$C_{\text{oss}}$	Output Capacitance		N		70		
			P		105		
$C_{\text{rss}}$	Reverse Transfer Capacitance		N		35		
			P		70		

**Electrical Characteristics** ( $T_A=25^\circ\text{C}$  Unless Otherwise Noted)

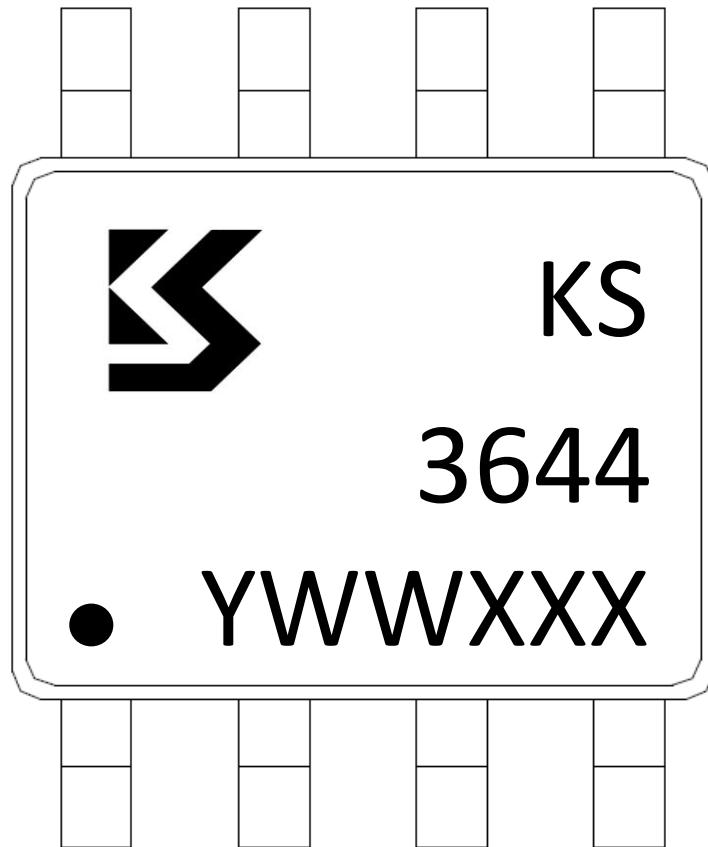
Symbol	Parameter	Test Condition	KS3644HA			Unit
			Min.	Typ.	Max.	
<b>Dynamic Characteristics<sup>⑥</sup></b>						
$t_{d(\text{ON})}$	Turn-on Delay Time	N-Channel $V_{DD}=15V$ , $I_{DS}=7A$ , $V_{GEN}=10V$ , $R_G=3\Omega$	N	6		ns
			P	7		
			N	9		
			P	11		
	Turn-off Delay Time	P-Channel $V_{DD}=-15V$ , $I_{DS}=-7A$ , $V_{GEN}=-10V$ , $R_G=3\Omega$	N	18		
			P	20		
			N	5		
			P	8		
<b>Gate Charge Characteristics<sup>⑥</sup></b>						
$Q_g$	Total Gate Charge	N-Channel $V_{DS}=15V$ , $V_{GS}=10V$ , $I_{DS}=7A$	N	9		nC
			P	14		
	Gate-Source Charge	P-Channel $V_{DS}=-15V$ , $V_{GS}=-10V$ , $I_{DS}=-7A$	N	2.8		
			P	3.7		
$Q_{gd}$	Gate-Drain Charge		N	3.5		
			P	5.2		

Notes:

- ①Pulse width limited by safe operating area.
- ②Calculated continuous current based on maximum allowable junction temperature.
- ③When mounted on 1 inch square copper board,  $t \leq 10\text{sec}$ . The value in any given application depends on the user's specific board design.
- ④Limited by  $T_{J\max}$ . Starting  $T_J = 25^\circ\text{C}$ , N Channel:  $L = 0.5\text{mH}$ ,  $R_G = 25\Omega$ ,  $I_{AS} = 6A$ ,  $V_{GS} = 10V$ , P-Channel:  $L = 0.5\text{mH}$ ,  $R_G = 25\Omega$ ,  $I_{AS} = -5A$ ,  $V_{GS} = -10V$ , Part not recommended for use above this value.
- ⑤Pulse test; Pulse width  $\leq 300\mu\text{s}$ , duty cycle  $\leq 2\%$ .
- ⑥Guaranteed by design, not subject to production testing.

**Ordering and Marking Information**

Device	Package	Packaging	Quantity	Reel Size	Tape width
KS3644HA	SOP8	Tape&Reel	3000	13"	12mm

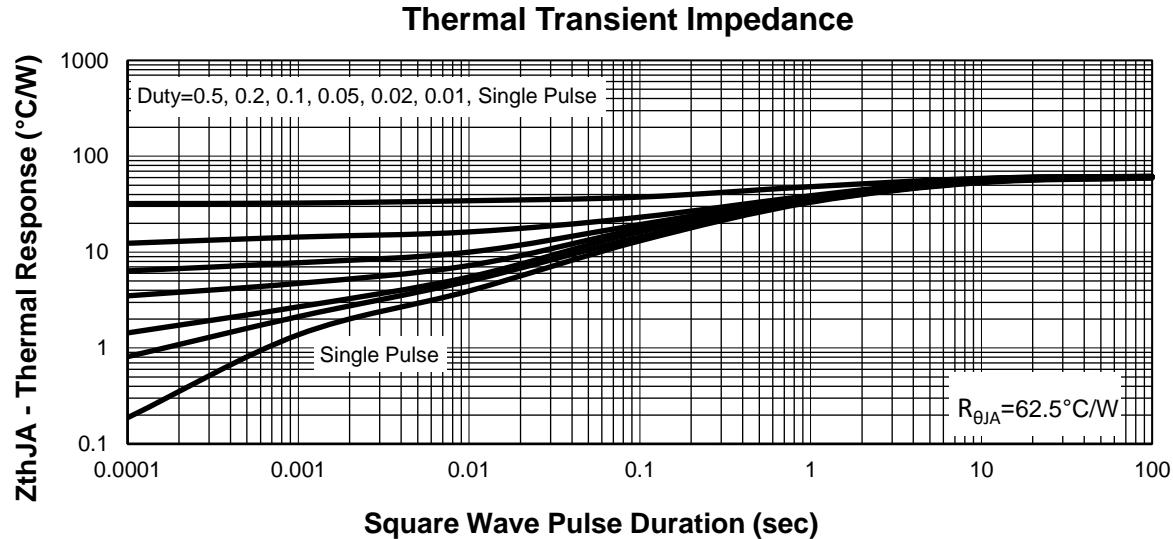
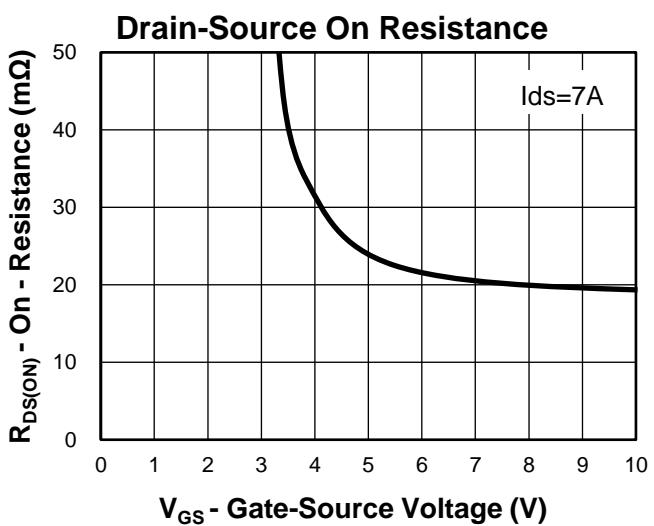
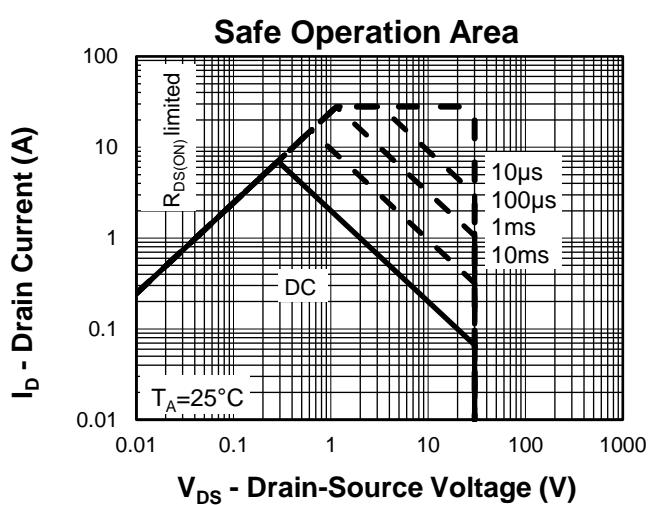
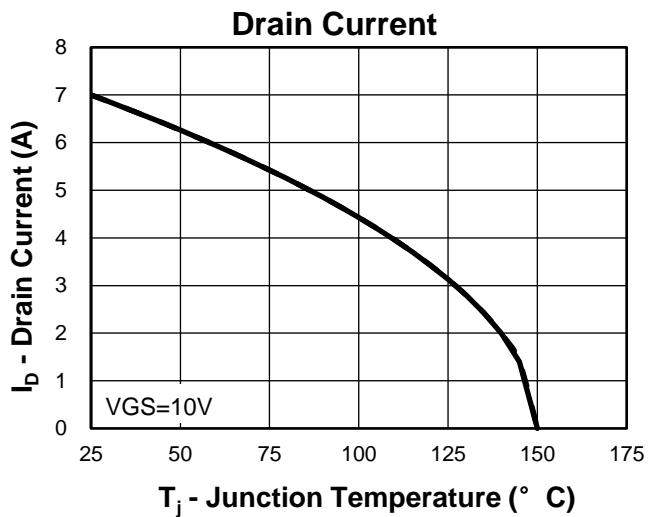
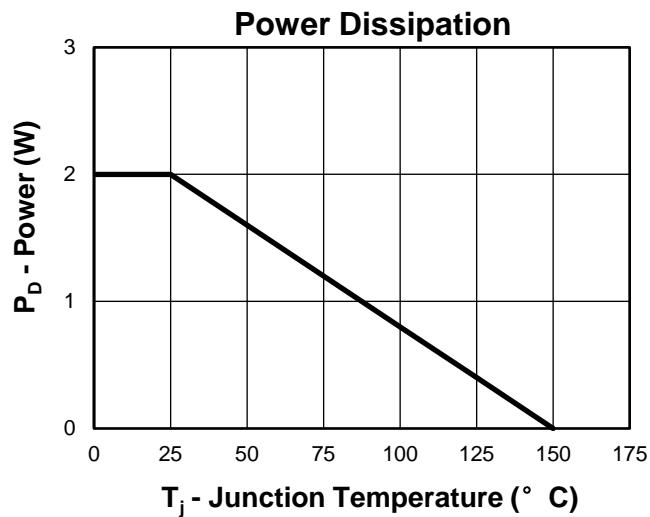


1st Line: Kwansemi LOGO, Kwansemi Code(KS)

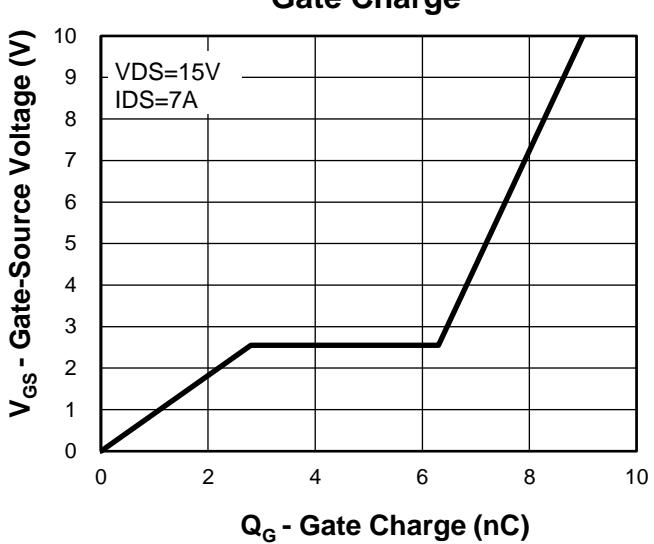
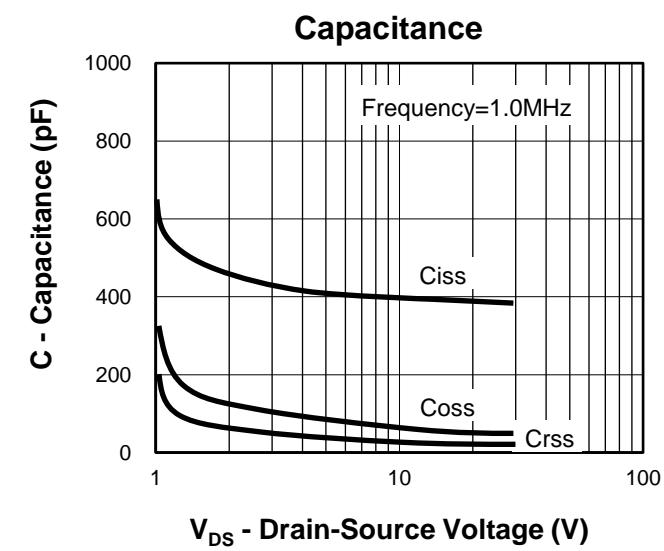
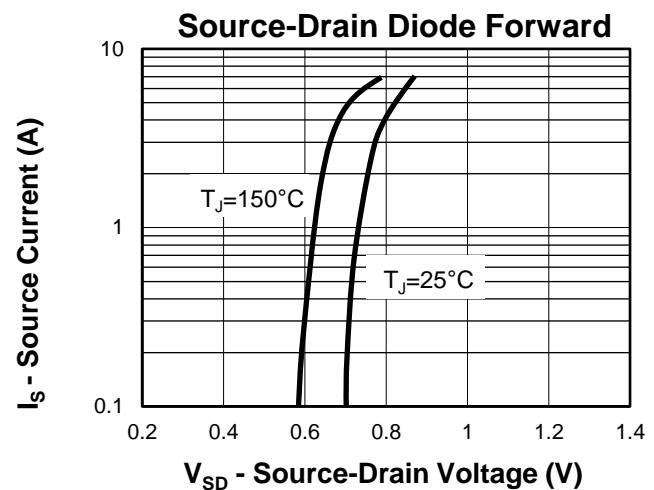
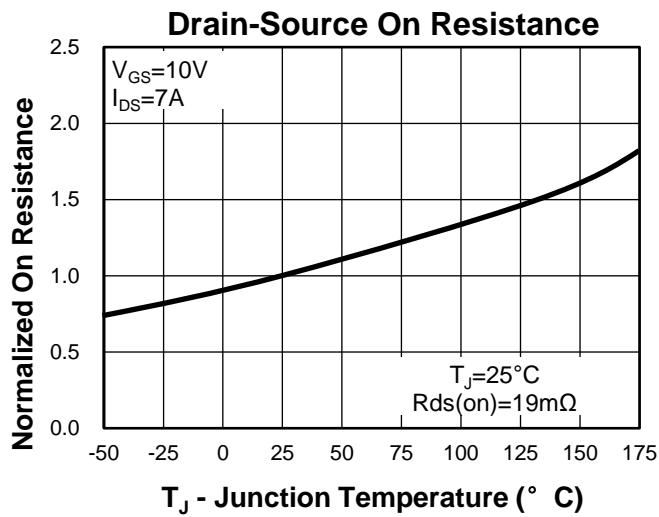
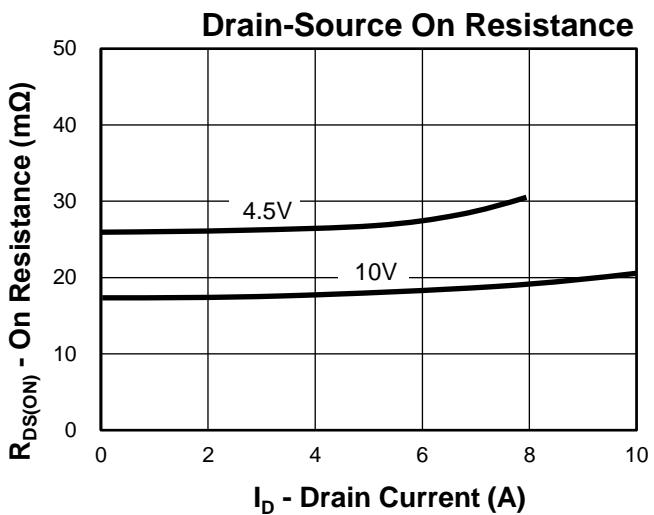
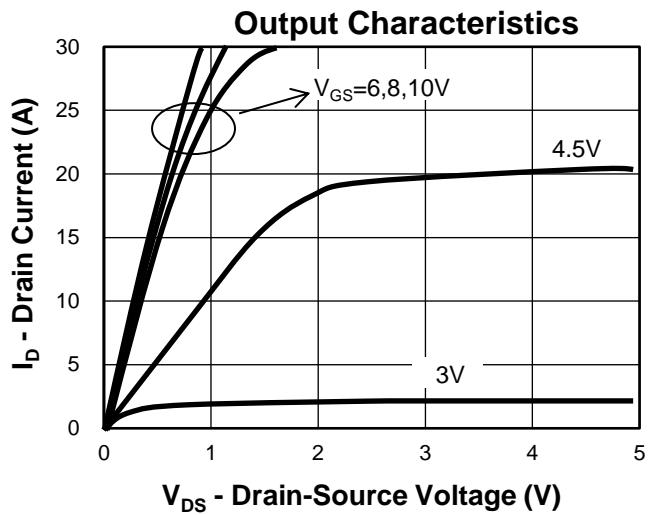
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3rd Line: Lot Number(YWWXXX)

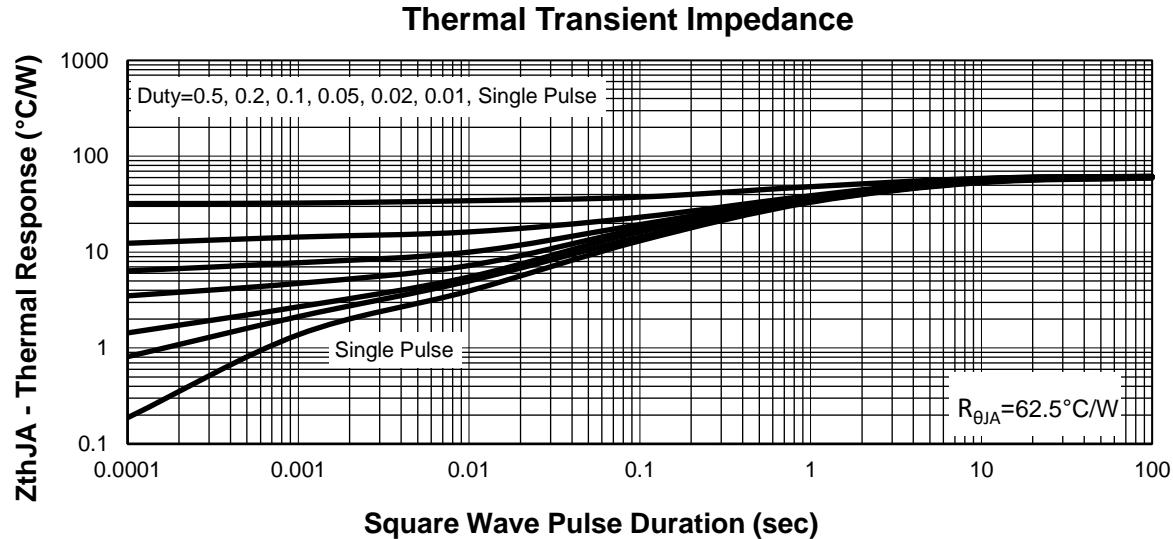
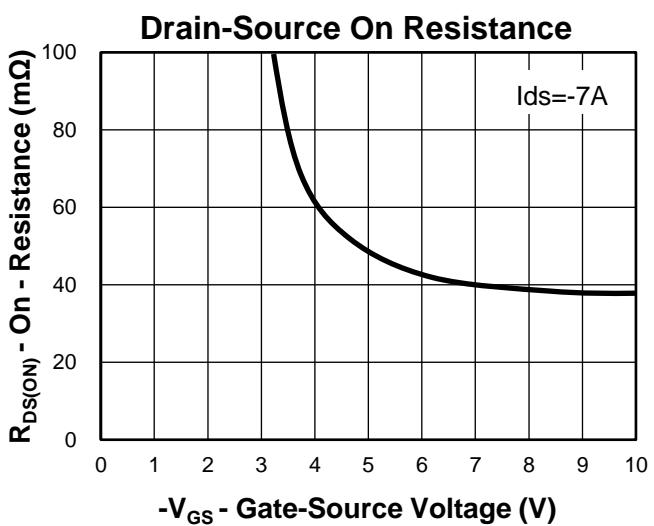
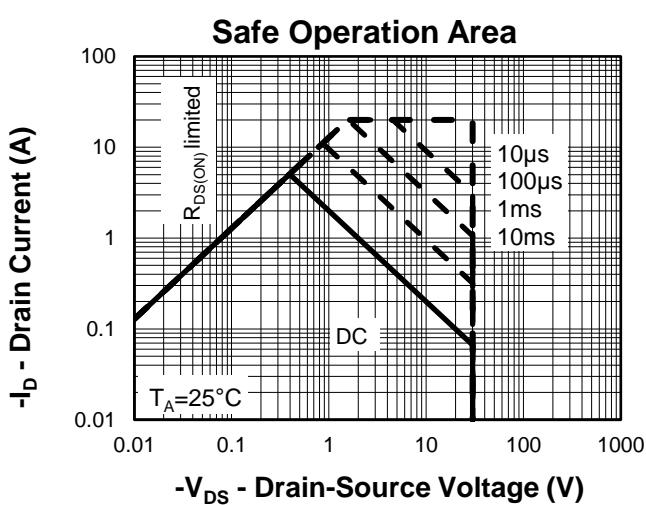
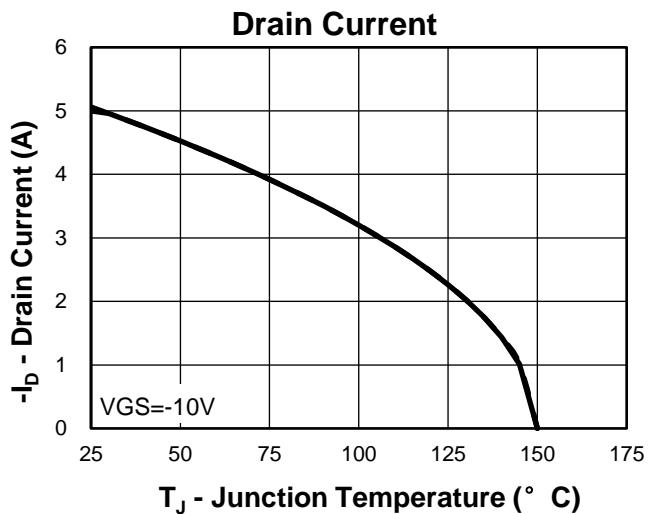
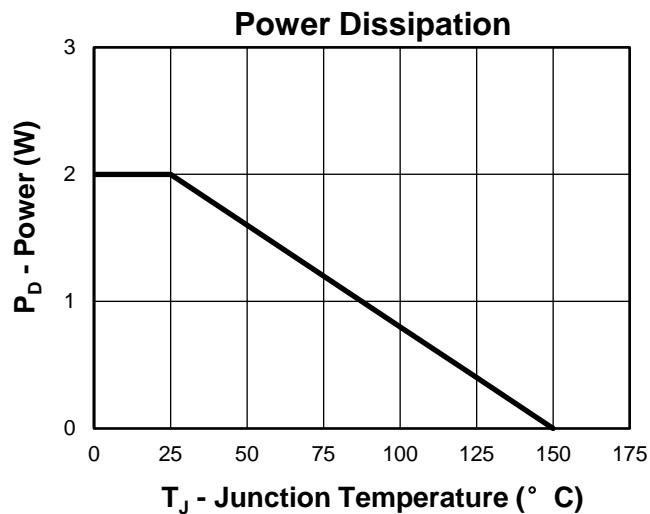
## Typical Characteristics(N-Channel)



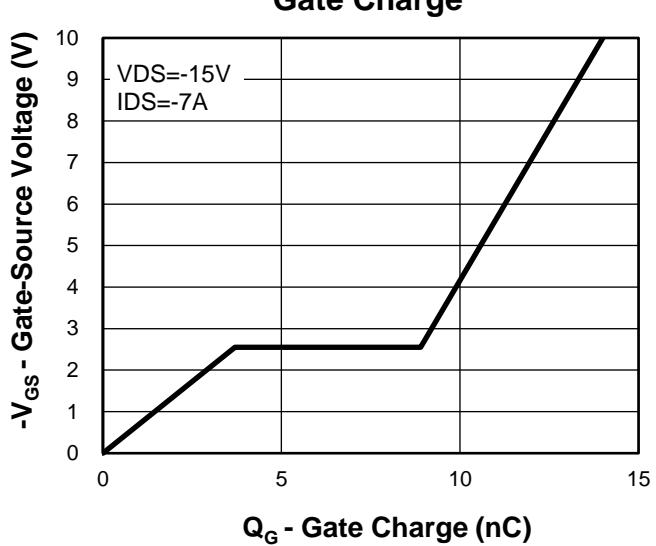
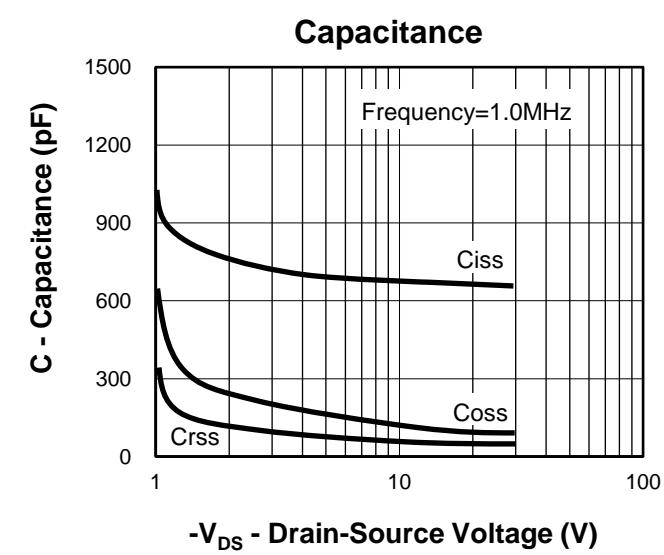
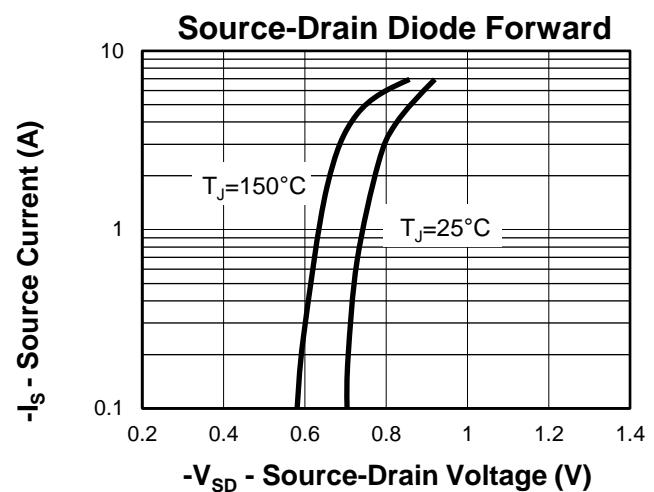
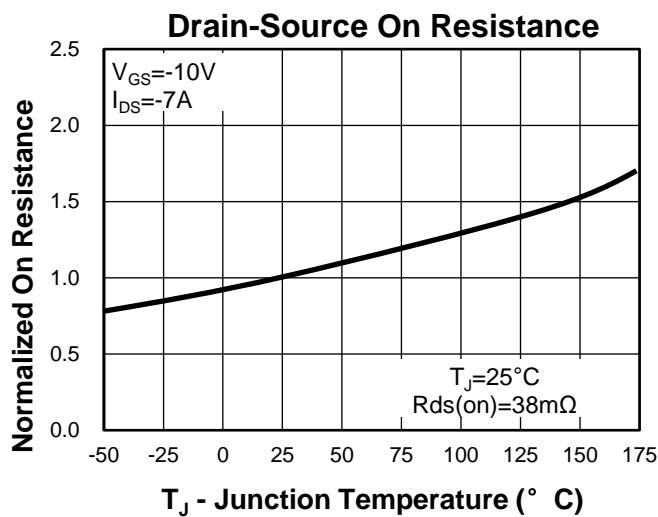
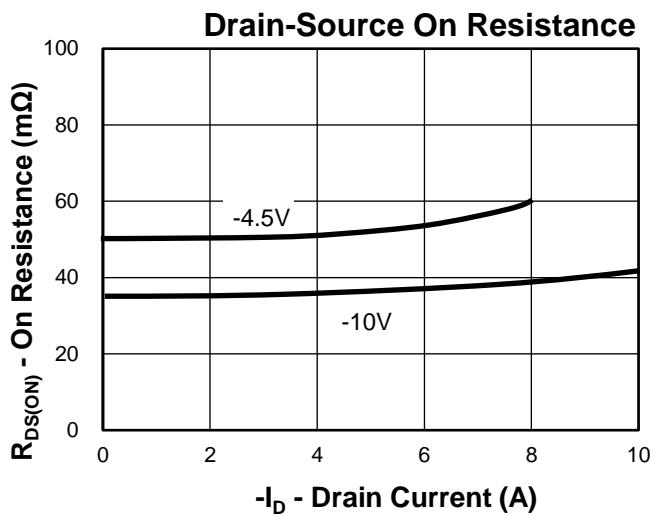
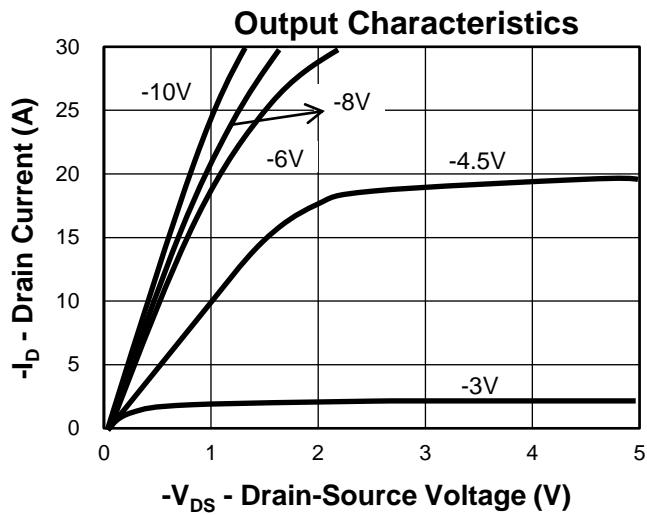
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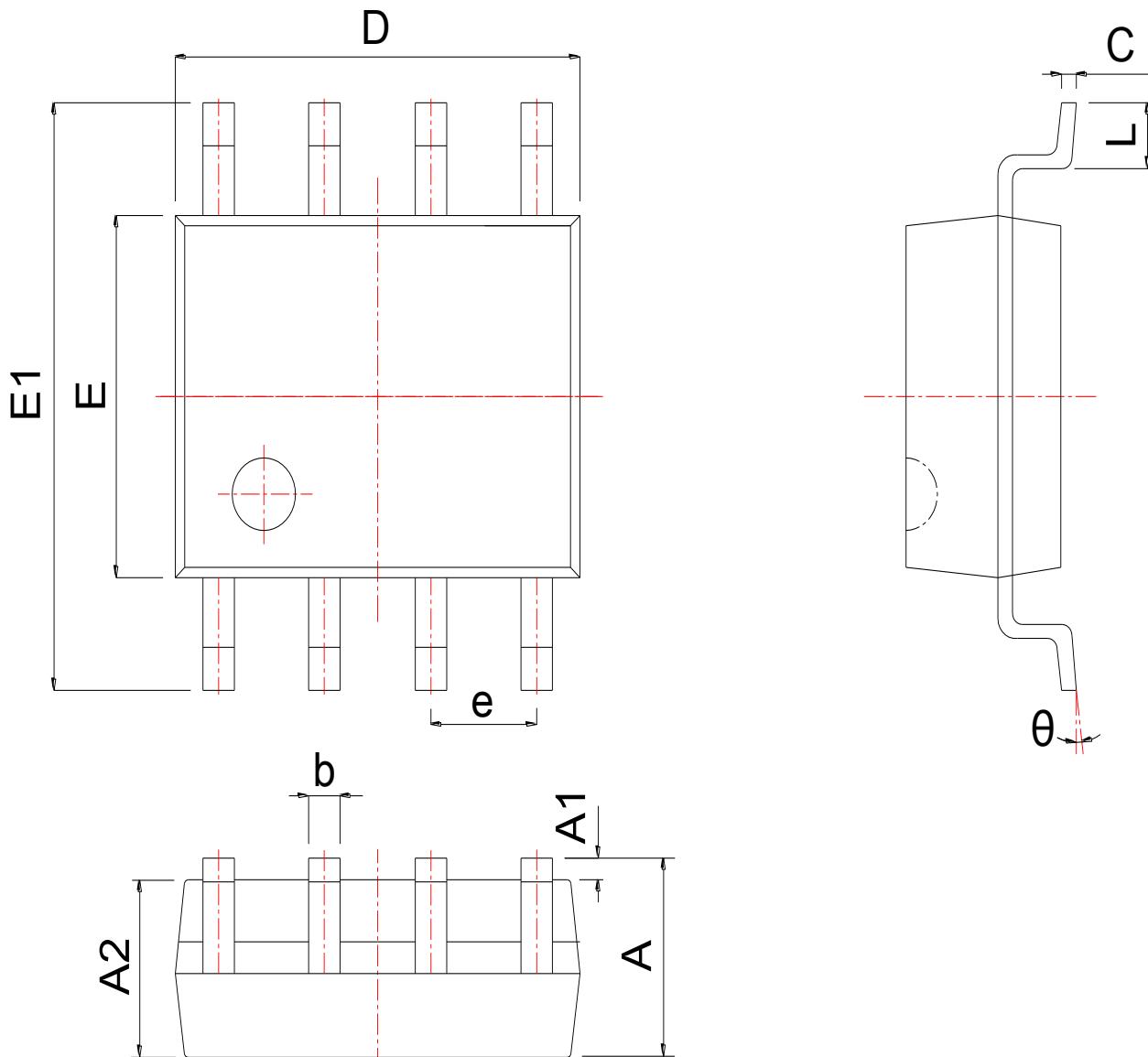


## Typical Characteristics(P-Channel)



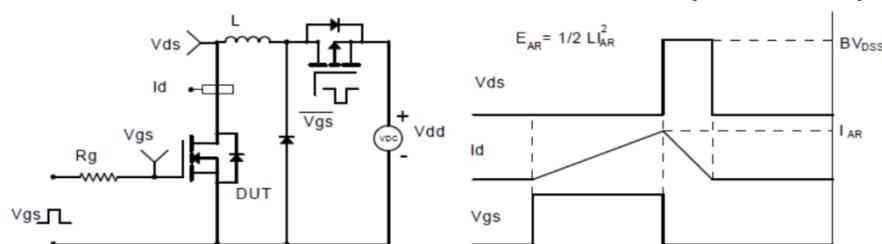
### Typical Characteristics(P-Channel)



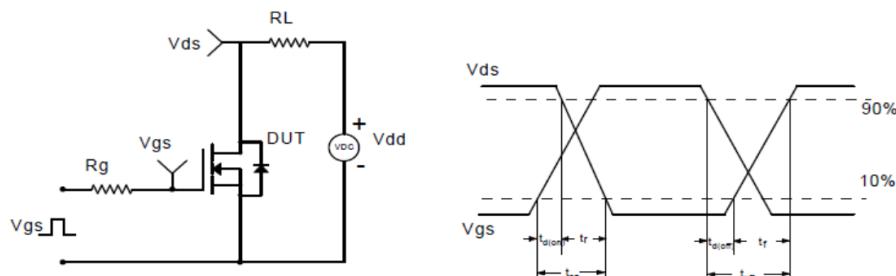
**Package Information**
**SOP8**


SYMBOL	MM			INCH		
	MIN	NOM	MAX	MIN	NOM	MAX
A	1.300	1.525	1.750	0.051	0.060	0.069
A1	0.050	0.150	0.250	0.002	0.006	0.010
A2	1.350	1.450	1.550	0.053	0.057	0.061
b	0.330	0.420	0.510	0.013	0.017	0.020
c	0.170	0.210	0.250	0.007	0.008	0.010
D	4.700	4.900	5.100	0.185	0.193	0.201
E	3.800	3.900	4.000	0.150	0.154	0.157
E1	5.800	6.000	6.200	0.228	0.236	0.244
e	1.270 BSC			0.050 BSC		
L	0.400	0.835	1.270	0.016	0.033	0.050
θ	0°		8°	0°		8°

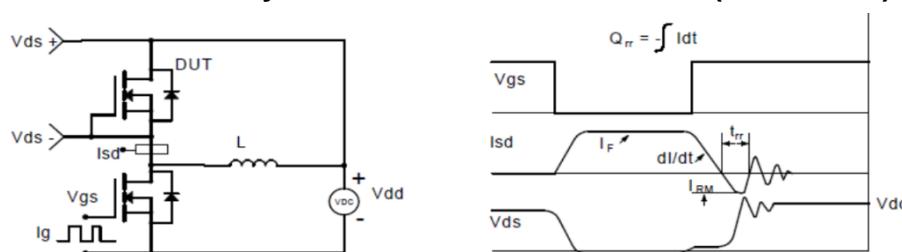
### Avalanche Test Circuit and Waveforms(N-Channel)



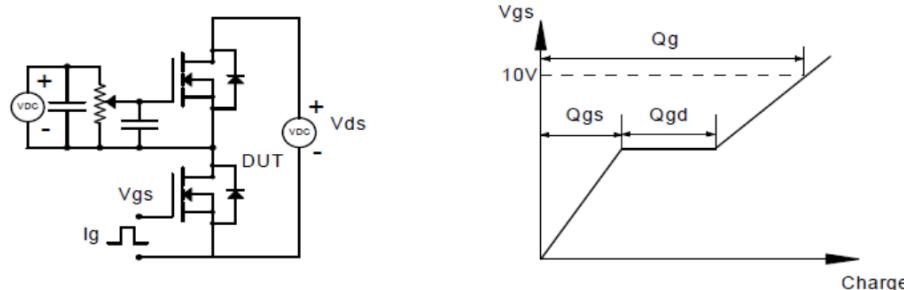
### Switching Time Test Circuit and Waveforms(N-Channel)



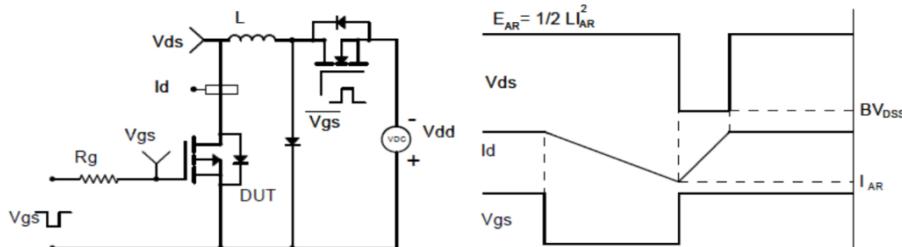
### Diode Recovery Test Circuit and Waveforms(N-Channel)



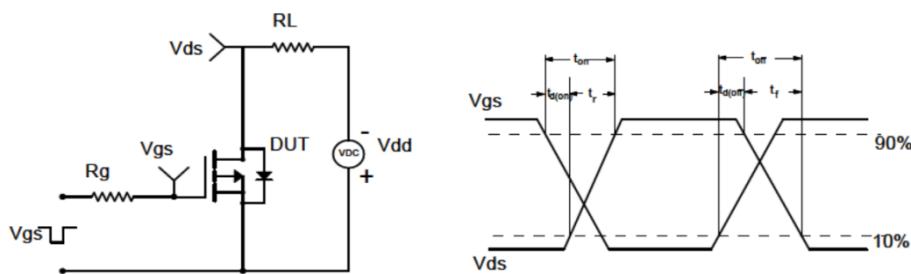
### Gate Charge Test Circuit and Waveform(N-Channel)



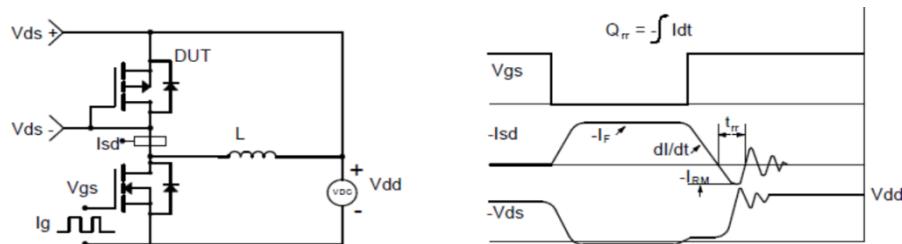
### Avalanche Test Circuit and Waveforms(P-Channel)



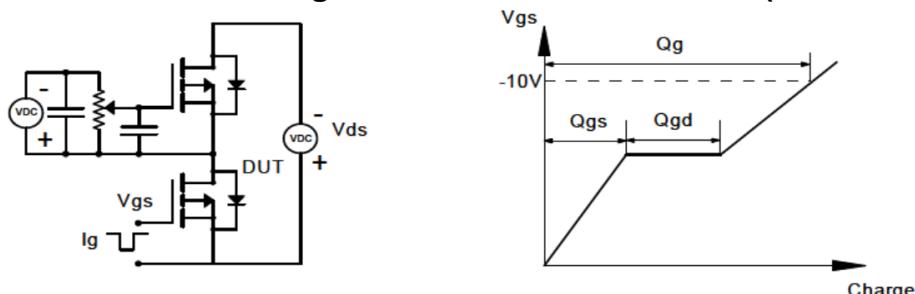
### Switching Time Test Circuit and Waveforms(P-Channel)



### Diode Recovery Test Circuit and Waveforms(P-Channel)



### Gate Charge Test Circuit and Waveform(P-Channel)



### Customer Service

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